

Birck Nanotechnology Center Discussion Forum on Future Centers of Excellence

***Summary of Meetings
December 16-17, 2020***

January 9th, 2021

Ali Shakouri
Zhihong Chen





Looking Ahead: Ten Big Ideas



Navigating the New Arctic




Harnessing Data for 21st Century Science and Engineering



Work at the Human-Technology Frontier: Shaping the Future


RESEARCH IDEAS



Understanding the Rules of Life: Predicting Phenotype



The Quantum Leap: Leading the Next Quantum Revolution



Windows on the Universe: The Era of Multi-messenger Astrophysics

PROCESS IDEAS



Growing Convergent Research at NSF



NSF-Includes: Enhancing Science and Engineering through Diversity

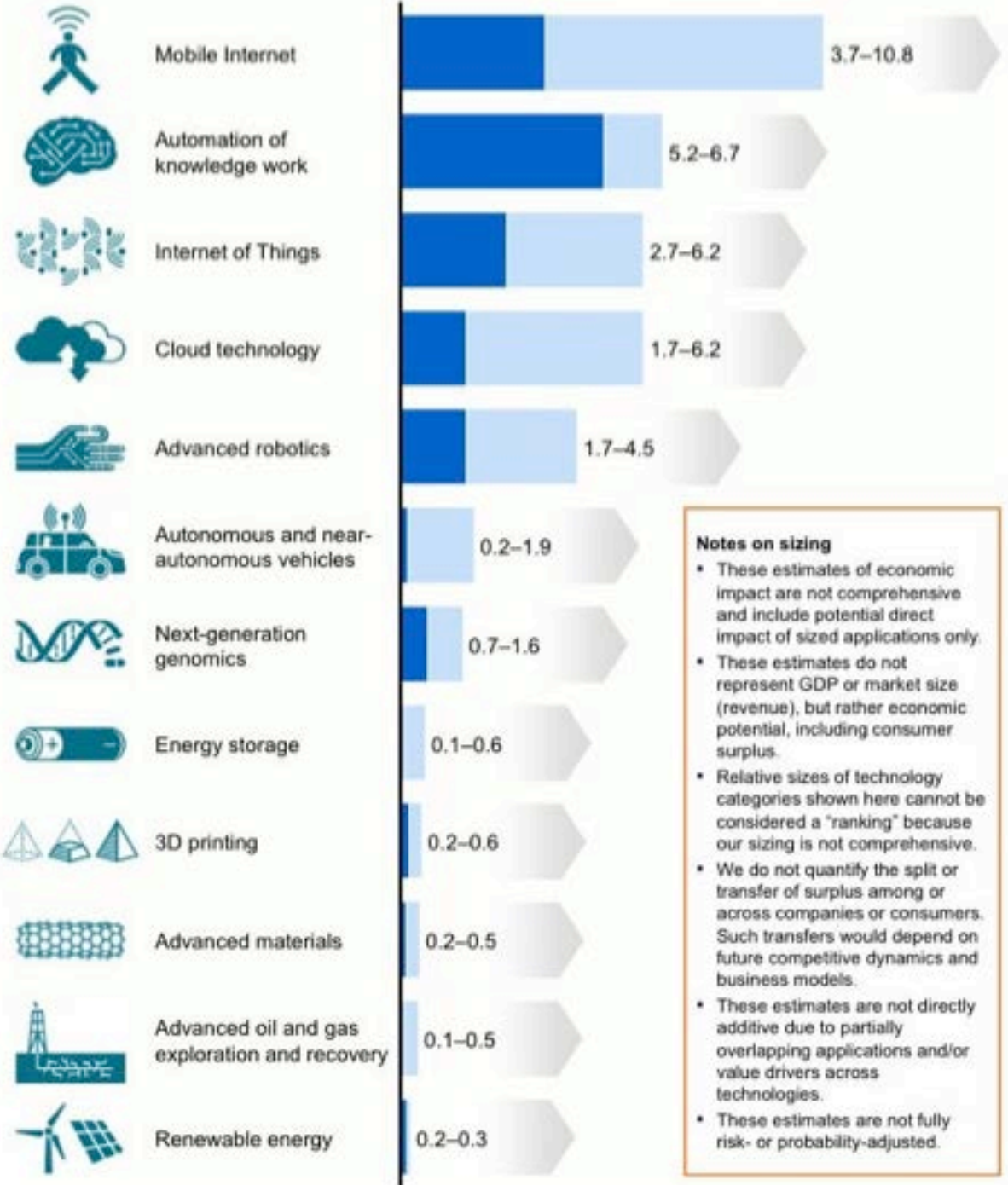


Mid-scale Research Infrastructure



NSF 2050: Seeding Innovation

Business Trends (\$T)



Notes on sizing

- These estimates of economic impact are not comprehensive and include potential direct impact of sized applications only
- These estimates do not represent GDP or market size (revenue), but rather economic potential, including consumer surplus.
- Relative sizes of technology categories shown here cannot be considered a "ranking" because our sizing is not comprehensive.
- We do not quantify the split or transfer of surplus among or across companies or consumers. Such transfers would depend on future competitive dynamics and business models.
- These estimates are not directly additive due to partially overlapping applications and/or value drivers across technologies.
- These estimates are not fully risk- or probability-adjusted.

McKensie
(2014)





SUSTAINABLE DEVELOPMENT GOALS

1 NO POVERTY

2 ZERO HUNGER

3 GOOD HEALTH AND WELL-BEING

4 QUALITY EDUCATION

5 GENDER EQUALITY

6 CLEAN WATER AND SANITATION

7 AFFORDABLE AND CLEAN ENERGY

8 DECENT WORK AND ECONOMIC GROWTH

9 INDUSTRY, INNOVATION AND INFRASTRUCTURE

10 REDUCED INEQUALITIES

11 SUSTAINABLE CITIES AND COMMUNITIES

12 RESPONSIBLE CONSUMPTION AND PRODUCTION

13 CLIMATE ACTION

14 LIFE BELOW WATER

15 LIFE ON LAND

16 PEACE, JUSTICE AND STRONG INSTITUTIONS

17 PARTNERSHIPS FOR THE GOALS



Global Megatrends (Discovery Park)

9.6 Billion
People
by 2050

Aging populations, rising cost of healthcare, global pandemics, sustainability



70% Increase in
Food Production
by 2030

Increasing need for water, urbanized population, land use and production capability, climate change



Global Conflict and Security

Technological and policy innovation are needed to secure our democracy and overcome global conflict and violence

60% of
Global Population
Middle Class by 2030

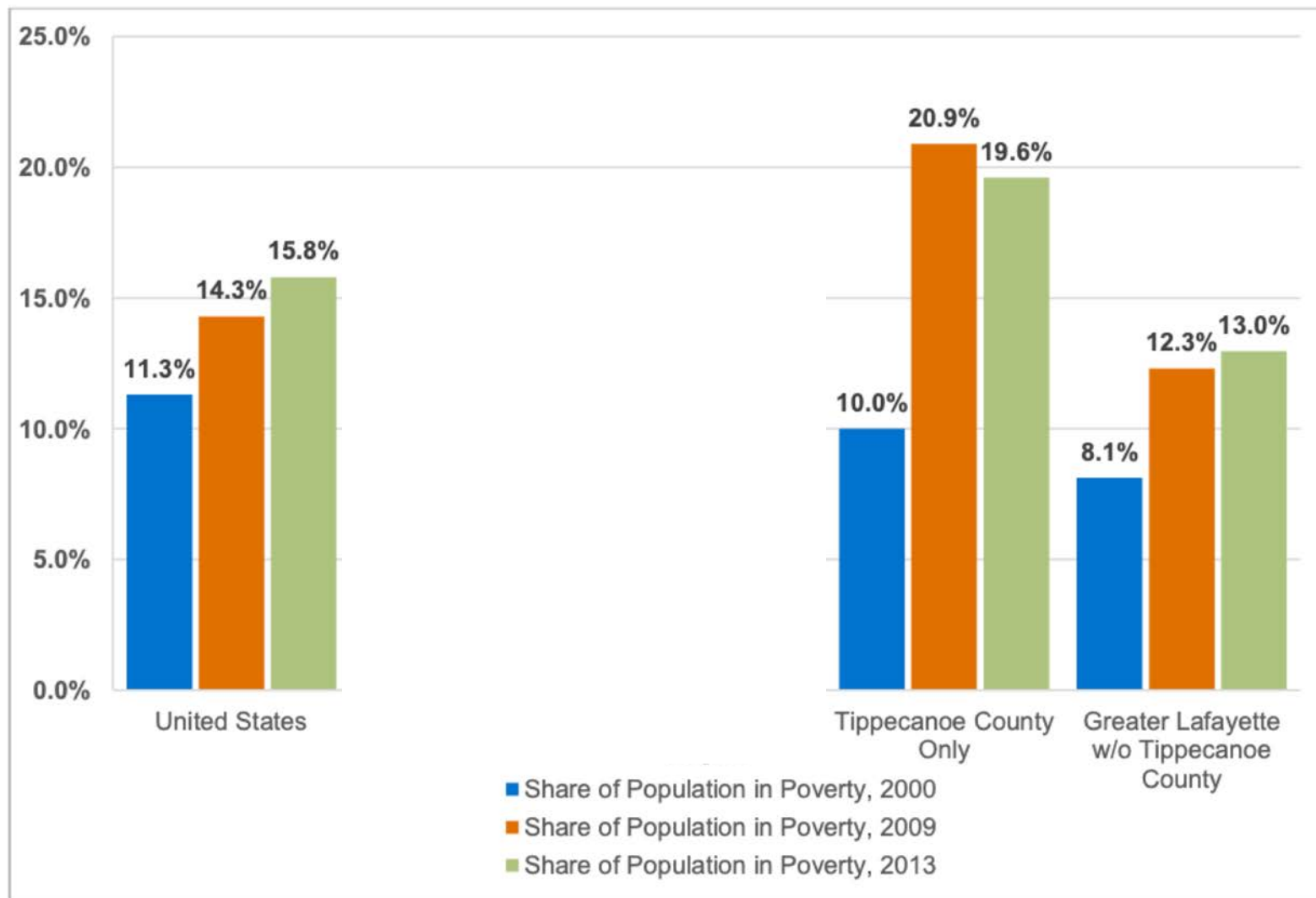
Shift to megacities, rising demand for energy, food, water



40% to 60% Increase in
Energy Demand
by 2050

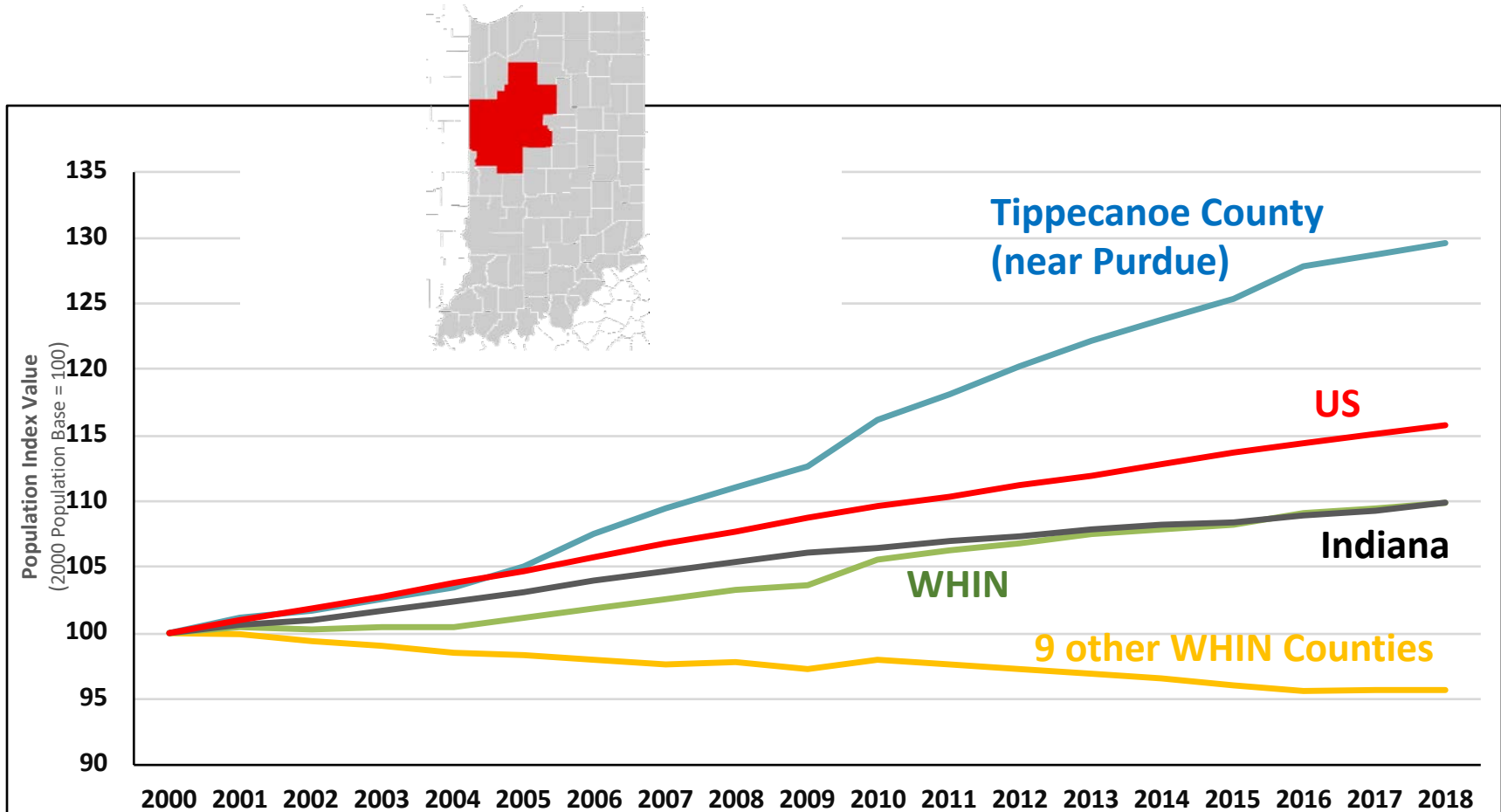
Finding solutions. Fossil fuel-based economy, integration of renewables, energy poverty, climate change

Figure 12. Share of Population Considered to be in Poverty



Source: U.S. Census, Small Area Income and Poverty Estimates (SAIPE), 2000, 2009, and 2013 (most recent available).

Population Trends in the Region, 2000-2018

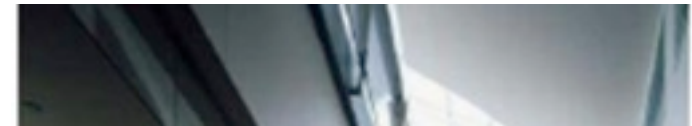


Regional Engagement: Wabash Heartland Innovation Network (WHIN): 2018-2022, \$38.9M
Birck Center, Ag, Engineering, Krannert and Polytechnic
(IoT sensors/data analytics, digital ag and next generation manufacturing)
<https://www.purdue.edu/whin/>

BNC Concept

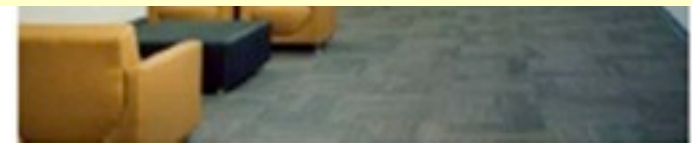
Engaging interdisciplinary, Societal-scale challenges and opportunities in healthcare, information access, energy, and the environment with approaches enabled by the latest science and engineering (nano, quantum, IoT, ...)

- Community encompassing a very broad span of disciplines in the same space
- Best facility and tools
- Fluid...no “ownership” of space
- Sustainable financial model



2007 Facility of the Year Award by Controlled Environments Magazine

Assisting the design of nano centers at MIT, Princeton, Stanford, UC Berkeley, Gatech, Penn State, Argonne as well as international centers at Mexico, Colombia, India, Kuwait and Qatar



Tim Sands 2009



BNC Resident Faculty & Main Research Thrusts

Research Thrusts		Resident Faculty
Electronics	6	Alam, Appenzeller, Z. Chen, Janes, Morisette, Ye
Photonics	9	Alaeian, Bermel, Boltasseva, Hosseini, Hung, Jacob, Kildishev, Narimanov, Shalaev
MEMS/ Microsystem	4	Bhave, Mohammadi, Peroulis, Weinstein
Cond. Matter Physics	5	Y. Chen, Ma, Malis, Manfra, Rohkinson
Thermal/ Packaging	8	Marconnet, L. Pan, Ruan, Shakouri, Warsinger, Weibel, Xu, Yazawa
R2R/ Manufacturing	7	Cakmak, Chiu, Mei, Rahimi, Stanciu, Wei, Ziaie
Nanobio/ Soft Materials/ LyoHUB	12	Cappelleri, Garner, Han, Lelievre, Mcnally, Panigrahi, Savran, Suter, Verma, Wereley, Alexeenko, Topp
Material Growth/ Char.	3	Capano, Marinero, Na, H. Wang, F. Ribeiro
AFM/ Surface	4	Raman, Reifenberger, Rhoads, Wagner

Resident Faculty 58: ECE 21, ME 14, Physics 7, MSE 5, Other Engineering 5, Other Science 2, Polytechnic 2, Pharmacy 1, Vet Med 1 + **Non-Resident Faculty:** ~70 (35 departments)

Students: 220 resident + 300 other users

Industry: Nanovis, Microsoft Station Q, LyoHUB (25 companies), SMART (5 companies)

All Equipment/Tools: BNC Wiki <https://wiki.itap.purdue.edu/display/BNCWiki>



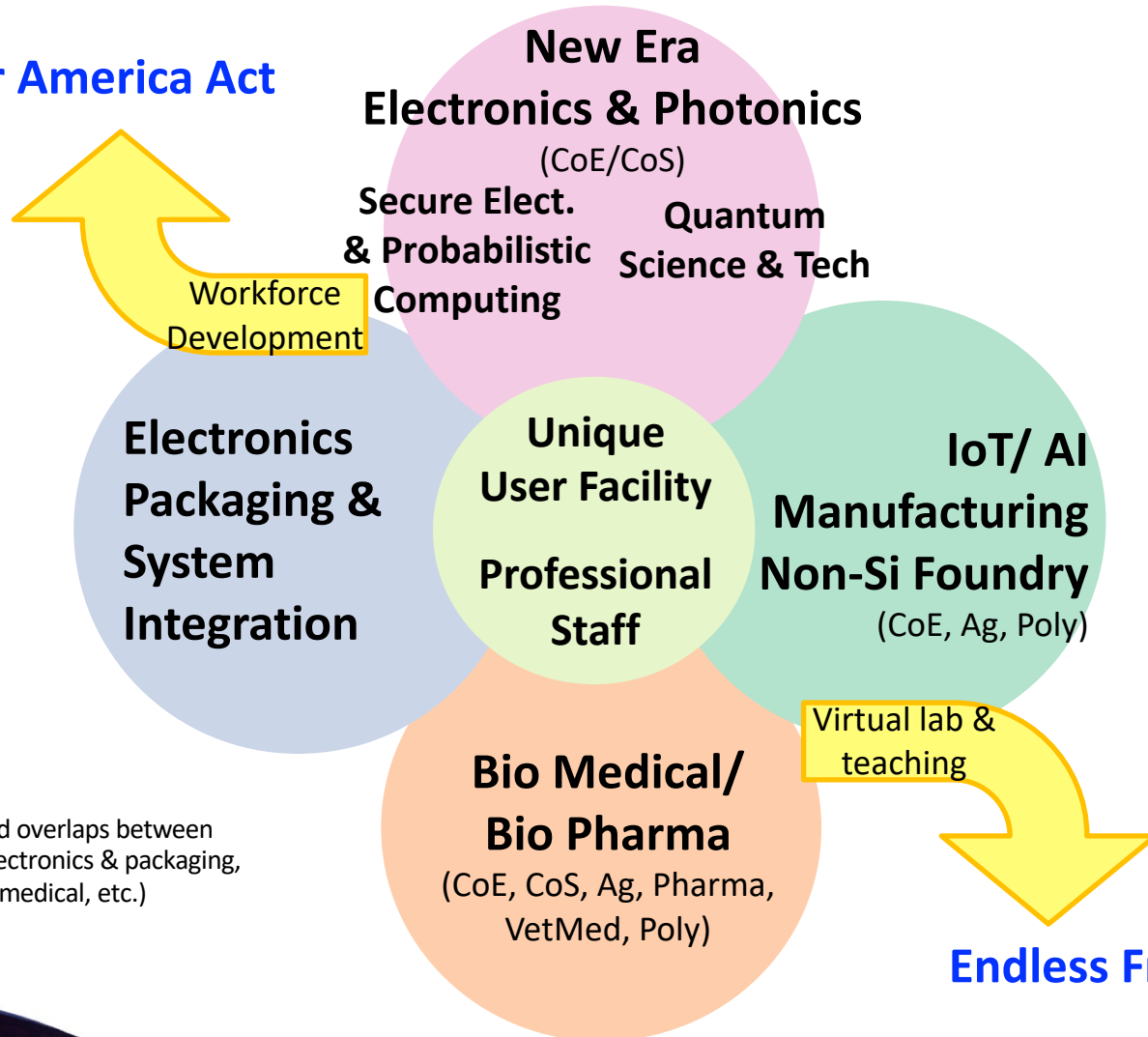
Birck Directors and Research Staff

Director	Ali Shakouri
Associate Director for Research	Zhihong Chen
Associate Director for Operation	Sunil Bhave
Research Manager	Tracy Hudson
Electron Microscopy	Rosa Diaz
Surface Science	Dima Zelmyanov
Optics	Alexei Lagoutchev
Processing, Electrical Characterization	Nithin Raghunathan
Biolabs/ 3D Cell Culture	Yunfeng Bai
Spintronics	Neil Dilley
PQSEI Managing Director	David Stewart
R2R Manufacturing	Nick Glassmaker
R2R In-line Characterization	Ye Mi
WHIN Managing Director	Ted Fiock
WHIN IoT Testbeds	Harris Mousoulis



Centers of Excellence based on Birck Annex Discussions (Aug. 2019-June 2020)

CHIPS For America Act



Endless Frontiers Act

* There are synergies and overlaps between sub-areas (e.g. secure electronics & packaging, system integration & biomedical, etc.)



(1) Biomedical/Engineering

Core Group: Rams Ramaswami, Chris Rochet, Bumsoo Hun, David Cappelleri, Babak Ziaie, Lia Stanciu, Alex Wei, Chi-Hwan Lee, Krishna Jayant, Rahim Rahimi, others?

CoE, CoS, Ag,
 Pharma, VetMed,
 Poly

Grand Challenges:

- Molecular processes inside living cells
- Microbiome
- Large area artificial skin
- Emergency response (point-of-care)

Technology:

- Frontiers of biological imaging
- Organoids/ Lab on a chip
- Digital human
- Micro soft-robotics inside the body
- Ubiquitous low-cost IoT devices
- Measurement science/ Analyt. Chem.

Endless Frontiers Act

Virtual lab & teaching

**Eli Lilly, Elanco,
 Roche, Industry
 Consortia, DoD
 and National Lab
 partnerships**

**PIIN, PI4D
 Bindley
 LyoHUB**



(2) Ag/Food Systems

Core Group: Tim Filley, Ajay Malshe, Rahim Rahimi, Travis Horton, David Warsinger, Carson Reeling, others?

Grand Challenges:

- Sustainability, food insecurity
- Carbon economy; nexus of energy, water and food

Ag, CoE, VetMed,
 Polytechnic

Technology:

- Ubiquitous low-cost IoT devices
- AI at the intersection of Cyber and Physical. Machine learning + physics models. ML extrapolating beyond training sets
- Modeling (ecosystem and socio-economic impact)

Manufacturing USA

**Regional Ecosystem
 (WHIN, DP District)**

**SMART,
 C4E,
 Plant Science
 Initiative**

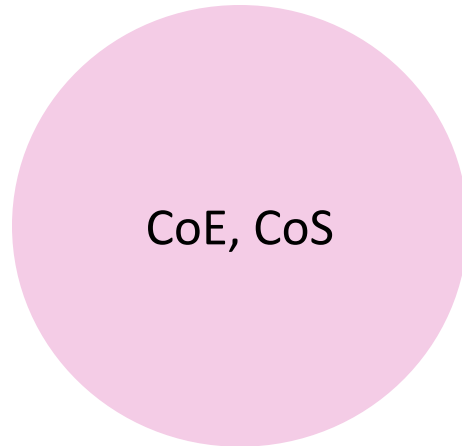


(3) Computing and Communications (electronics, photonics, 3D heterogenous integration)

Core Group: Zhihong Chen, Joerg Appenzeller, Peide Ye, Gerhard Klimeck, Yong Chen, Peter Bermel, Sunil Bhave, Vlad Shalaev, Zubin Jacob, Chen-Lung Hung, Justin Weibel, Haiyan Wang, Xinghang Zhang, Shriram Ramanathan, Wenzhou Wu, Letian Dou, others?

Grand Challenges:

- 5G and beyond
- Secure electronics
- Others?



Technology:

- Hybrid Quantum and AI technologies
- Electronics packaging and 3D heterogeneous system integration
- Probabilistic computing
- Quantum electrodynamics and metrology
- Hybrid photonics and superconducting electronics

CHIPS For America Act

Workforce Development

**PQSEI
nanoHUB
PINE
iGSDI**

**Microsoft, SRC,
TSMC, LM,
Intel, Samsung,
Crane, Draper,
Sandia, Oak Ridge**

**National
Initiatives in
Quantum, AI and
Trusted
Electronics**



(4) Manufacturing

Core Group: Miko Cakmak, Jan-Anders Mansson, Jan Allebach, Jianguo Mei, Ashraf Alam, Bruno Ribeiro, Xianfan Xu, Xinghang Zhang, John Sutherland, Ali Shakouri, others?

Grand Challenges:

- Distributed scalable and secure manufacturing
- Sustainable manufacturing (minimum energy/water use, recycling)
- Training of future workforce

Technology:

- AI at the intersection of Cyber and Physical. Machine learning + physics models. ML extrapolating beyond training sets
- AI Human/Machine interface
- Technical cost modeling
- 3D nano manufacturing
- Develop a foundry for non-silicon IoT devices near Purdue (roll-to-roll manufacturing)

CoE,
 Polytechnic,
 Krannert

Manufacturing USA

**Regional
 Ecosystem
 (WHIN)**

**SMART
 IMI
 IN-MaC**



(A) Local Community Engagement

Core Group: Ali Shakouri, Ted Fiock, Karthik Kannan, Ajay Malshe, Purdue-WHIN Team, Others?

Leverage WHIN project, expand beyond ag and manufacturing

- Privacy-preserving regional AI network for scalable and secure manufacturing
- AI for healthcare, future of insurance
- AI for workforce training, eLearning, future of work
- Smart roads/ infrastructure; Leverage DP District

**LEI's WHIN
Project**



(B) Interdisciplinary Collaborations, Increase Purdue visibility

Core Group: Sorin Matei, Neil Dilley,
Sasha Boltasseva, Others?

Increase visibility of Purdue research nationally or internationally

- Collaboration with **Brian Lamb School, Art & Design** (e.g. storytelling course modules, future thematic Purdue 2050 Conferences, ...)
- Develop “demonstrators” highlighting Purdue’s “first-best-only” (ideas by Sorin Matei and Dimitri Peroulis)

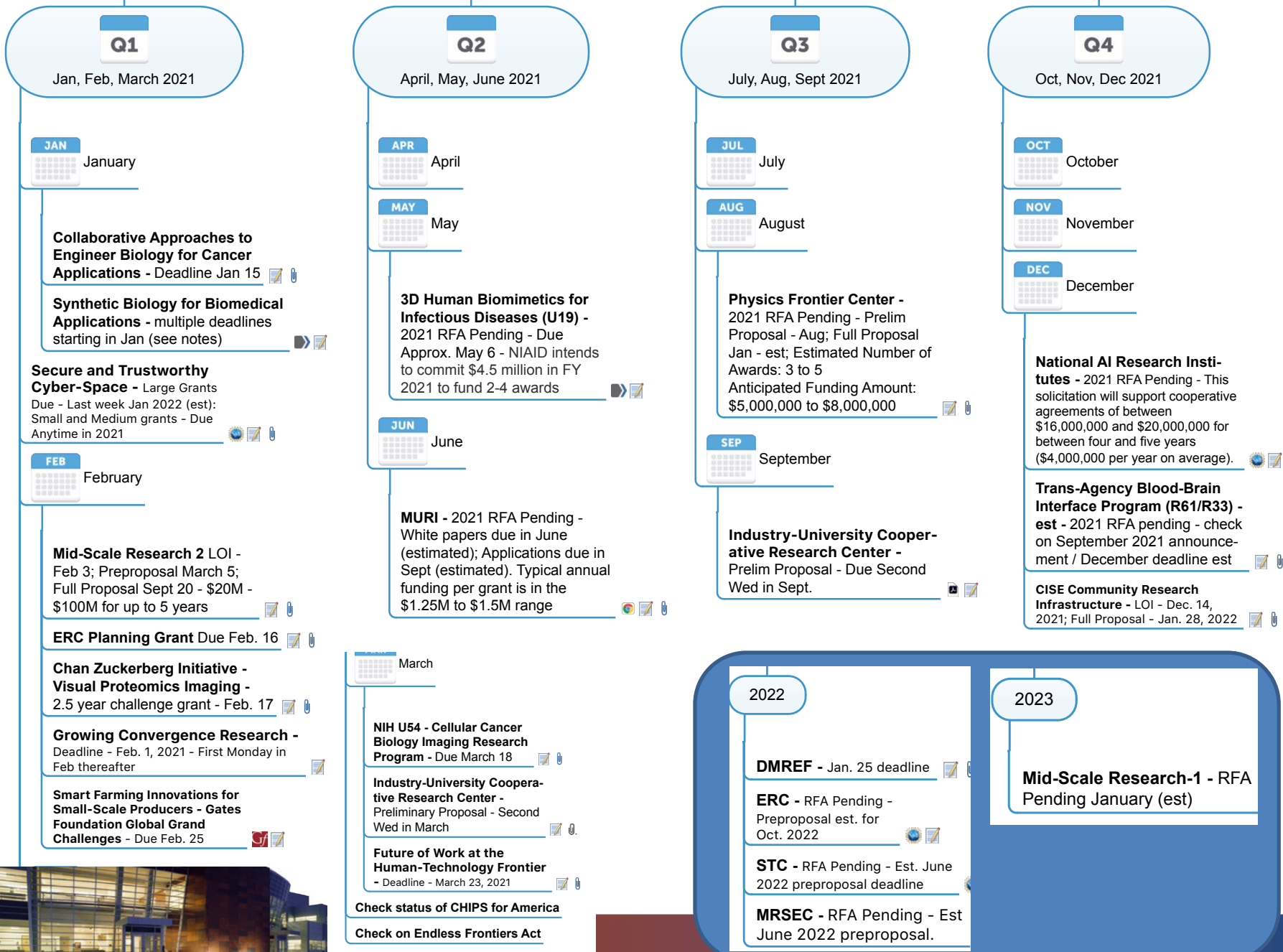


Major center proposals are great opportunities to put together interdisciplinary teams, but we need to start working 2-3 years in advance. We should be better prepared for new programs (e.g. NSF AI Institutes, Mid-Scale Instrumentation), but we should also leverage non-traditional funding sources

- Foundations, philanthropic
- Industry consortia
- Leverage contacts through Lewis-Burke, IEDC, etc.
- Partnerships with Lilly, Elanco, Roche, Rolls-Royce, GE or other local companies



Potential Grant Timeline (2021 and beyond)

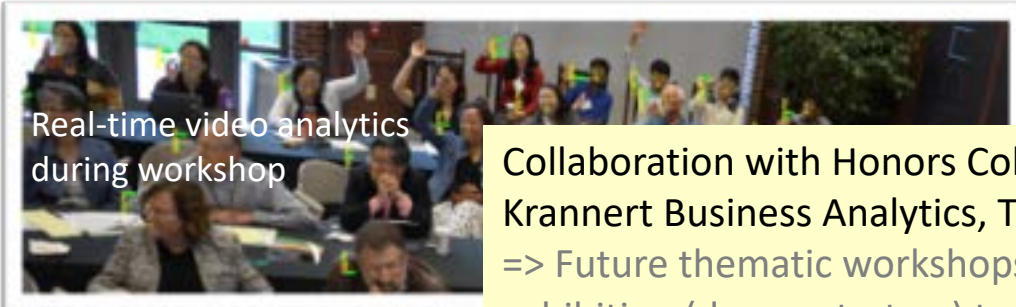


Purdue 2050: Conference of the Future



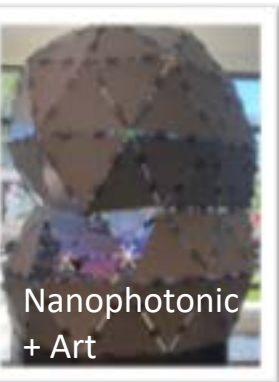
September 26-27, 2019, Honors College

Link to talks: <https://www.purdue.edu/discoverypark/2050/>

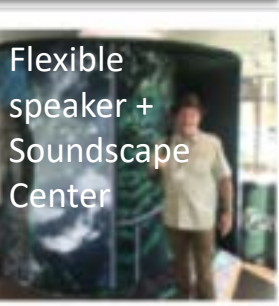
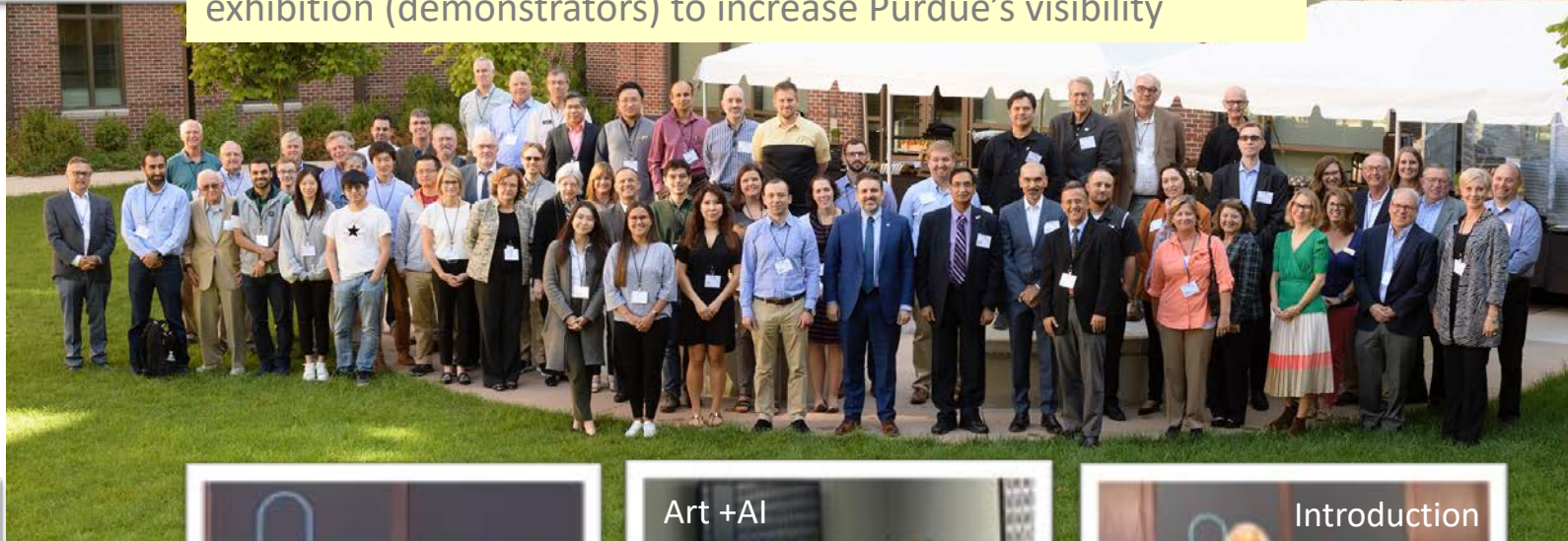


Real-time video analytics during workshop

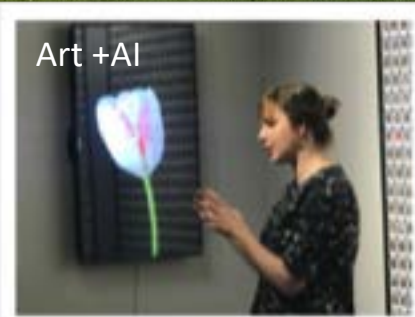
Collaboration with Honors College, College of Liberal Arts, Krannert Business Analytics, The Data Mine, Regenstreif Center => Future thematic workshops/conferences with unique exhibition (demonstrators) to increase Purdue's visibility



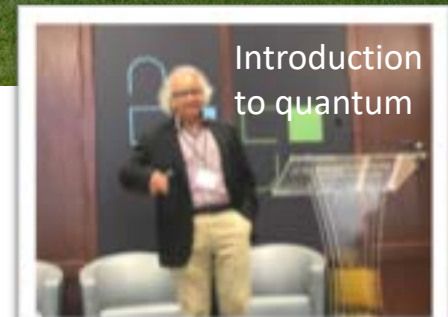
Nanophotonic + Art



Flexible speaker + Soundscape Center



Art + AI

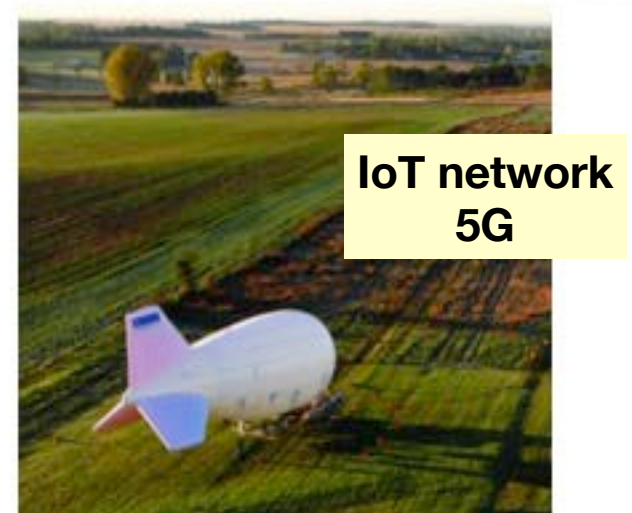


Introduction to quantum

Leverage WHIN and DP District

Real-time sensors and living labs (Birck, IMI, Manufacturers) used to teach data science, AI, system of systems

- Example: NSF I-USE: Polytech/
Birck: B. Newell, K. Yazawa, A. Magana, A. Shakouri Circuits, Fluid Power and Applied Thermodynamics
- Other courses that can leverage living labs?



Example: Potential Collaboration DPD/ WHIN RTO Wireless Aerostat



Convergence Building

CARR
WORKPLACES
CONVERGENCE

PURDUE'S NEWEST HOME FOR INNOVATION,
COLLABORATION, AND PRODUCTIVITY



Whether you need short term space for an ad hoc meeting or more long term space in the form of a private office, Carr Workplaces Convergence offers a variety of workspace options.



PRIVATE OFFICES



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COWORKING



TEAM ROOMS



MEETING ROOMS



EVENT SPACE

Industry collaborators
on campus

(765) 300-4974 | carrworkplaces.com/convergence
101 Foundry Drive, Suite 1200 West Lafayette, IN 47906

1. Helping Multi-disciplinary Teams Excel (strategic agenda)
 - Strengthen PI network –Journal club, BNC seminars, co-teach classes, unexpected interactions/ lunches
 - Develop mentoring networks –Seek advice from faculty with experience in small and large centers (MURI, EFRC, STC, ERC,...)
 - Communicating Birck stories -Storytelling competition, workshop/ EdX/ nanoHUB short courses, Purdue 2050 Conference
2. Develop New Centers
 - Scouting for weak signals -Fed. budget allocations, i.e. Lewis-Burke
 - Program manager interaction
 - Multi-PI and center proposal opportunities
3. Help Create a Local High Tech Ecosystem
 - Community IoT Testbeds WHIN; DP District Living Lab.

Strategic Doing Framework: persistence, regular follow up

Kirk Grant: consultants to (1) help teams with Strategic Doing, (2) help with major grants supporting strategic research directions

How Can Purdue Compete with Other Centers of Excellence?



Competition: SMART films & R2R manufacturing

Top Universities/groups in SMART films /low-cost IoT devices

- Stanford, Berkeley, MIT, UC San Diego

Top Centers in R2R manufacturing:

- Umass Amherst (\$25M): Strength in polymers & nano-materials
- Univ. of Washington (\$30M): focused on solar cells and batteries (energy applications)
- NextFlex (\$75M): Hybrid IC chip integration (short term, complementary)
- Holst Center/IMEC (\$150M): focused on IP generation, existing tools/ fab in Asia

How Purdue will position itself?

- (1) Full vertical integration (from materials & manufacturing to IoT systems and data analytics), applications to sustainable ag/food, healthcare, emergency response, infrastructure
- (2) Foundry for non-silicon IoT devices.
- (3) AI/machine learning applied to privacy-preserving resilient and distributed manufacturing
- (4) Regional IoT testbeds in ag and manufacturing (\$38.9M WHIN project)



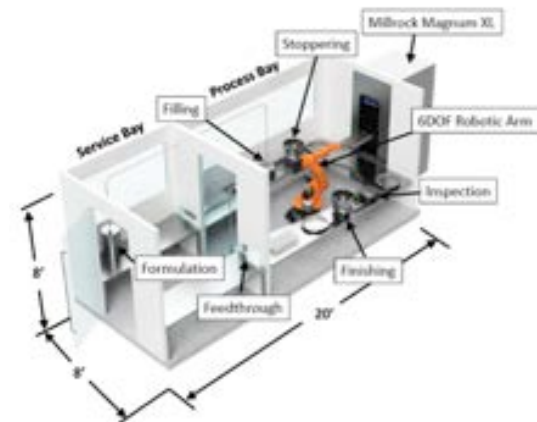
Top Centers in Biomedical /Pharma manuf. and how Purdue will position itself:

- Biomedical: Harvard, UCSF, Stanford, ... (strong medical schools)
- Pharma: NCSU, NJIT, Rutgers (strong pharma programs, engineering not at the level as Purdue)

There are very strong biomedical facilities in major universities with top Medical Schools. Purdue has a highly ranked Vet School. Purdue's investment in Health Sciences can leverage Birck by:

- (1) Strengthening the connection with CoE (ECE, ME, MSE, microfabrication, heterogenous system integration and packaging), CoS (Measurement Science)
- (2) Basic biological science studies using organoids on a chip and microfluidics
- (3) Pharma manufacturing (collaboration Engineering/ Pharmacy), FDA training

Purdue is also uniquely positioned to take advantage of the major shared resources in Indiana, with strong on-going collaborations with biomedical industry: Lilly, Elanco, Roche, etc.



Top Centers in Quantum and how Purdue will position itself:

Multiple new quantum centers in US, extremely sophisticated in their lab space. e.g.

- U Chicago (Awschalom led, constantly expanding very aggressively, esp. photonics)
- Caltech (Amazon is starting a new building there)
- Harvard (internal funding of over \$5M for quantum)
- Maryland (Joint Quantum Institute, esp. in AMO physics)
- Colorado (JILA Center with NIST -- AMO physics, recent expansion in engineering)
- UIUC (IQUIST center, >\$10M funding)
- UCSB (site of Microsoft station Q and NSF quantum materials foundry)
- Berkeley (strength in superconductor quantum computing etc.)
- Yale Quantum Institute (strength in superconductor quantum computing etc.)
- Pittsburgh Quantum Institute
- U Penn (combining Physics + ECE)
- Colombia Quantum Initiative

PQSEI has strong faculty in quantum materials/devices (esp. based on semiconductors or topological/2D materials, building on strengths in condensed matter physics in PHYS and microelectronics/nanotech in ECE) and quantum photonics (esp. ultrafast quantum photonics, quantum plasmonics, with strengths in AMO physics in PHYS and field/optics in ECE), well positioned to develop unique and novel hybrid quantum systems (e.g. interfacing ultrafast quantum photonics with electronic-spintronic systems) and quantum sensing technologies (with broad applications)



Competition: Packaging/System Integration

Top centers in packaging and systems and how Purdue will position itself:

- **GTech:** One of the largest university electronics packaging centers (SRC).
- **UIUC:** Large interdisciplinary team with POETS Center on electro-thermal systems
- **Maryland:** CALCE Electronics Products and Systems center with industry sponsors; Test Services and Failure Analysis (TSFA) Laboratory
- **SUNY Binghamton:** Close collaboration with IBM; S3IP Center of Excellence
- **Auburn:** CAVE³ (NSF Center): Surface Mount Assembly and Electronic Packaging facilities

Purdue has unique strengths in reliability physics, heterogeneous integration, 3D packaging, and thermal management with vibrant industry consortia: CTRC (NSF) and CHIRP (SRC). Rather than applied testing and throughput, Purdue will differentiate via high-fidelity characterization tools that offer unique abilities to extract scientific understanding, develop physical models, and determine root cause.

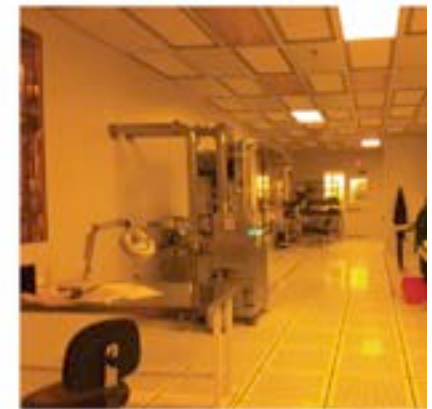


Competition: Secure Electronics

Top Centers in Secure/Trusted Electronics and how Purdue will position itself:

- **Vanderbilt** (radiation hard electronics)
- **MIT** (semiconductor electronics)
- **Berkeley** (microelectronics)
- **Stanford** (3D chip design)

Purdue has very strong microelectronics simulation and experimental research, as well as education programs with high external reputation. Given the new opportunities in microelectronics and secure electronics, Purdue is well positioned to lead both research and education in these directions.



Other Potential Centers

- **Collaboration with other Discovery Park Centers**
(Bindley, PIIN, PI4D, C4E, iGSDI, IDSI, PPRI, nanoHUB, etc.)
- **Herrick/ Zucrow Collaboration? (DoD, DoE)**
- ...



- NSF ERC, STC, MRSEC, Mid Scale Instrumentation
- NSF DMREF, CPS (\$1-2M programs, 3-5 PIs)
- NSF AI Institutes (What can we do at the interface of virtual and physical?)
- DoD MURI (Topics decided by PM, initiate ideas?)
- DARPA Programs (Topics decided by PM, initiate ideas?)
- DOE EFRC (Next round topics haven't come out)
- NIH Programs
- USDA Programs

Leverage Lewis-Burke (Purdue consultants in Washington)

Major Center Proposals:

- + Brings the team together. Learn from best practices. Specific deadlines.
- Very small success rate. Couple efforts on major centers with other smaller proposals (obtain preliminary results working in small groups)



Title	Deadline	Funding No. / Amt	Summary
Planning Grants for Engineering Research Centers (ERC)	February 16, 2021	20 Funded / \$2,000,000	The ERC program intends to support planning activities leading to convergent research team formation and capacity- building within the engineering community. This planning grant solicitation is designed to foster and facilitate the engineering community’s thinking about how to form convergent research collaborations.
Engineering Research Center (ERC)	LOI Sept. 2023 (Estimated)	1 to 5 Funded / Approx. \$26,000,000 (may be up to \$130,000,000 like Gen IV)	<p>The NSF Engineering Research Center (ERC) program supports convergent research, education, and technology translation at U.S. universities that will lead to strong societal impacts.</p> <ul style="list-style-type: none"> • Need strong industry engagement (funding) • RFP every 2 years: LOI Sep. 2, Preproposal Oct. 2, 2020; Full May 07, 2021 • Next round expected: Preproposal – 2022; Proposal – 2023
Science and Technology Centers (STC)	LOI June 2023 (Estimated) Limit on Number of Proposals per Organization: 3	\$25M for 5 years (Approx.)	<p>STCs conduct world-class research through partnerships among academic institutions, national laboratories, industrial organizations, and/or other public/private entities, and via international collaborations, as appropriate.</p> <ul style="list-style-type: none"> • ~ \$5M/year for 5 years with possibility of a 5 year continuation • RFP every three years: Preproposal – Jun. 25, 2019; Full - Jan. 27, 2020 • Next round expected: Jun., 2022



Title	Deadline	Funding No. / Amt	Summary
Materials Research Science and Engineering Centers (MRSEC)	LOI June 2022 (Estimated) Limit on Number of Proposals per Organization: 1	Range from \$2.6 million/year for a 2-IRG MRSEC to a maximum of \$4 million/year for a 3-IRG MRSEC.	The MRSECs program provides sustained support of interdisciplinary materials research and education of the highest quality while addressing fundamental problems in science and engineering. <ul style="list-style-type: none"> • Compete every three years: Preproposal – Jun. 24, 2019; Full proposal – Nov. 26, 2019 • Next round expected: Jun., 2022
Mid-scale Research Infrastructure-1	Prelim Proposal Jan. 2023 (Estimated)	Implementation projects - range from \$6M - \$20 million. Design projects - minimum request of \$600,000 / max request up to but not including \$20 million.	NSF defines Research Infrastructure (RI) as any combination of facilities, equipment, instrumentation, or computational hardware or software, and the necessary human capital in support of the same. Major facilities and mid-scale projects are subsets of research infrastructure. <ul style="list-style-type: none"> • Need Project Execution Plan • RFP every two years: Jan. 7, 2021; Proposal – Apr. 23, 2021 • Next round expected: Jan. 2023

[NSF Mid-scale Research Infrastructure-2](#)

Equipment, instrumentation, cyberinfrastructure, broadly used large-scale data sets, and the commissioning and/or personnel needed to successfully complete the project. Should fill a research community-defined scientific need, or address an identified national research priority, to be competitive in a global research environment.

Deadlines: February 3, 2021 – LOI; March 5 – Preliminary proposal, September 20 – Full proposal
\$20-\$100 million up to five (5) years.

Mary Nauman

Title	Deadline	Funding No. / Amt	Summary
Designing Materials to Revolutionize and Engineer our Future (DMREF)	January 11, 2021 - January 25, 2021 (annual deadline expected)	Range from \$1,200,000 – \$1,800,000 / duration of four years.	DMREF is the primary program by which NSF participates in the Materials Genome Initiative (MGI) for Global Competitiveness. MGI recognizes the importance of materials science and engineering to the well-being and advancement of society and aims to "deploy advanced materials at least twice as fast as possible today, at a fraction of the cost."
National Artificial Intelligence (AI) Research Institutes	December 04, 2020 Limit on Number of Proposals per Organization: 2	This solicitation will support cooperative agreements of between \$16,000,000 and \$20,000,000 for between four and five years (\$4,000,000 per year on average).	The National AI Research Institutes program – a joint effort of NSF, USDA-NIFA, DHS S&T, DOT FHWA, and several industry partners – will fund Institutes comprising scientists, engineers, and educators united by a common focus on advancing the research frontiers in AI. AI Research Institutes will have as their primary focus the advancement of multidisciplinary, multi-stakeholder research on larger-scale, longer-time-horizon challenges in AI research than are supported in typical research grants.
Department of Defense Multidisciplinary Research Initiative (MURI)	<ul style="list-style-type: none"> • White Papers: June, 2021 (Approx) • Applications: Sept. 2021 (Approx) 	Typical annual funding per grant is in the \$1.25M to \$1.5M range.	The MURI program supports basic research in science and engineering at U.S. institutions of higher education (hereafter referred to as "universities") that is of potential interest to DoD. The program is focused on multidisciplinary research efforts where more than one traditional discipline interacts to provide rapid advances in scientific areas of interest to the DoD.



Chris Rochet jrochet@purdue.edu

Department of Medicinal Chemistry and Molecular Pharmacology
Purdue Institute for Integrative Neuroscience

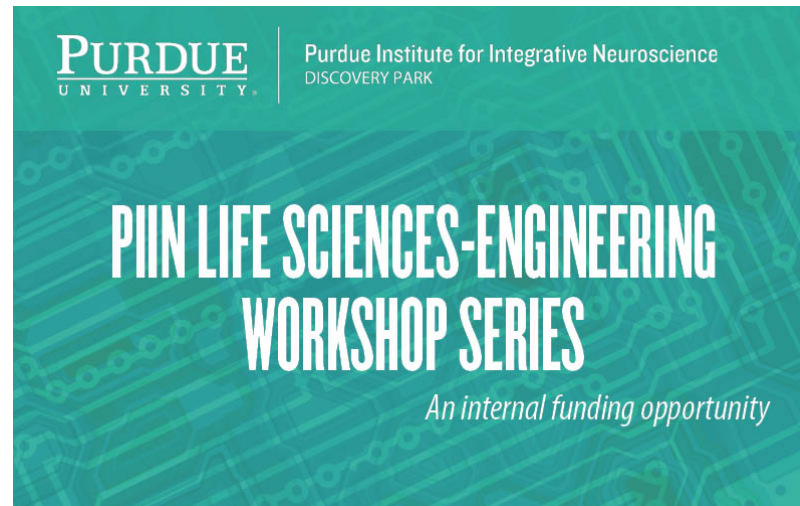
PIIN was created to bring together Purdue life scientists and engineers with interests in neuroscience.



The Institute is a leader at the *intersection between life sciences and engineering*, serving students and faculty at Purdue University, engaging a broad team of *collaborators throughout Indiana and the world*, and seeking to improve the human condition.



Opportunities for Collaboration between Life Sciences and Engineering



Research teams identified major problems requiring engineering solutions in:

- age-related neurodegenerative disorders
- neurotrauma
- neurodevelopmental disorders (e.g. autism)
- addiction
- hearing/communication disorders



Relevant Grant Opportunities

NIH

PAR-20-055 (R01): Engineering Next-Generation Human Nervous System Microphysiological Systems

RFA-NS-20-006 (R01): BRAIN Initiative – Biology and Biophysics of Neural Stimulation and Recording Technologies

RFA-MH-20-135: BRAIN Initiative – Tools to Facilitate High-Throughput Microconnectivity Analysis

NSF

NSF-21-532: Reproducible Cells and Organoids via Directed-Differentiation Encoding (RECODE)

NSF-21-517: Integrative Strategies for Understanding Neural and Cognitive Systems



The Chan Zuckerberg Initiative (CZI)

Visual Proteomics Imaging

2.5-year challenge grants. The ability to view protein molecules in cells and monitor changes in their structure, quantity, distribution, and interactions is key to understanding what causes diseases and finding treatments and cures. This grant program will advance technology development for the field of visual proteomics and aim to obtain near-atomic resolution readouts inside the cell.

Applications due February 17, 2021

<https://chanzuckerberg.com/wp-content/uploads/2020/12/Visual-Proteomics-RFA-Announcement-and-Instructions-COMBINED.pdf>

National Institutes of Health ([NIH](#)), National Cancer Institute ([NCI](#))

Cellular Cancer Biology Imaging Research (CCBIR) Program

(U54, Clinical Trial Not Allowed)

U54 Specialized Center- Cooperative Agreements, RFA-CA-21-002

Application Due Date(s) March 18, 2021

<https://grants.nih.gov/grants/guide/rfa-files/RFA-CA-21-002.html>



([NIH](#)) Cancer ([NCI](#)) Biomedical Imaging and Bioengineering ([NIBIB](#))

Collaborative Approaches to Engineer Biology for Cancer Applications [U01](#) RFA-CA-20-054

This funding opportunity announcement (FOA) invites applications to develop and apply innovative synthetic biology approaches to address challenges across the spectrum of cancer research. Projects will be required to apply a technology, based on an engineered biological system, to an important and well-defined cancer research question. Collaborative transdisciplinary teams are expected with PIs representing expertise in cancer research, engineering, and other disciplines relevant to synthetic biology.

Application Due Date(s) January 15, 2021

<https://grants.nih.gov/grants/guide/rfa-files/RFA-CA-20-054.html>

Notice of Special Interest (NOSI): **Synthetic Biology for Biomedical Applications**

NOT-EB-20-017

Release Date: November 24, 2020

Research Objectives

- develop tools and technologies to control and reprogram biological systems.
- apply synthetic biology approaches for the development of biomedical technologies.
- increase the fundamental understanding of synthetic biology concepts as they relate to human health.
- gain fundamental biological knowledge through the application of synthetic biology approaches.

https://grants.nih.gov/grants/guide/notice-files/NOT-EB-20-017.html?utm_campaign=+45044992&utm_content=&utm_medium=email&utm_source=govdelivery&utm_term=



Three-Dimensional (3D) Human Biomimetics for Infectious Diseases (U19) RFA-AI-20-009

This Funding Opportunity Announcement (FOA) will establish Human Biomimetics for Infectious Diseases Cooperative Research Centers (Biomimetics CRCs) focused on multidisciplinary research advancing and/or developing innovative *in vitro* human-cell- or -tissue-derived three-dimensional (3D) models for basic and translational research on infectious diseases.

Application Due Date(s) May 29, 2020

<https://grants.nih.gov/grants/guide/rfa-files/rfa-ai-20-009.html>

Trans-Agency Blood-Brain Interface Program (R61/R33) RFA-HL-20-021

Support high risk/high reward research on the blood/vascular component and regulation of the neurovascular-blood unit (a.k.a., Blood-Brain Barrier; BBB) in normal and pathological states to create enhanced/modified platforms that more closely model the human BBB. Research addressing vascular, hemostatic, hematopoietic, and/or immune cell interaction across the Blood-Brain Interface is of particular interest. This initiative will serve to stimulate the development of a new field of science and re-define the neurovascular unit to also include the blood/vascular component to develop the next generation of pre-clinical human cellular model systems of the human BBB to complement research currently based on animal models.

Application Due Date(s) December 2, 2019, December 11, 2020

<https://grants.nih.gov/grants/guide/rfa-files/RFA-HL-20-021.html>



Some grant opportunities (NSF):

Physics Frontier Centers: (repeats every 3 yrs)

Preliminary Proposal: August 01, 2019, **Full Proposal:** January 30, 2020

Awards: 3 to 5, **Funding Amount:** \$5,000,000 to \$8,000,000

<https://www.nsf.gov/pubs/2019/nsf19578/nsf19578.htm>

Quantum Leap Challenge Institutes (QLCI)

Preliminary September 01, 2020 Round II QLCI proposals.

Full Proposal February 01, 2021, Round II QLCI full proposals (by invitation only).

Challenge Institute (CI): \$5,000,000/year for 5 years.

<https://www.nsf.gov/pubs/2019/nsf19559/nsf19559.htm>

Industry-University Cooperative Research Centers Program (IUCRC)

Prelim.: March 10, 2021, Second Wednesday in March, Annually Thereafter

Prelim.: September 08, 2021, Second Wednesday in September, Annually Thereafter

\$150,000 per year for Phase I

<https://www.nsf.gov/pubs/2020/nsf20570/nsf20570.htm>

